## Package Outline Drawing



M8.15C 8 Lead Narrow Bod

8 Lead Narrow Body Small Outline Exposed Pad Plastic Package (EPSOIC)

	Inches		Millimeters		
Symbol	Min	Max	Min	Max	Notes
А	0.056	0.067	1.422	1.700	-
A1	0.0	0.005	0.0	0.13	-
В	0.0138	0.0192	0.35	0.49	9
С	0.0075	0.0098	0.19	0.25	-
D	0.189	0.196	4.80	4.98	3
E	0.150	0.157	3.811	3.99	4
е	0.050 BSC		1.27 BSC		-
Н	0.230	0.244	5.84	6.20	-
h	0.010	0.016	0.25	0.41	5
L	0.016	0.035	0.406	0.89	6
Ν	8		8		7
α	0°	8°	0°	8°	-
Р	-	0.126	-	3.200	11
P1	-	0.099	-	2.514	11
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Notes:

- 1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion, and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
- The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- 9. The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch).
- 10. Controlling dimension: Millimeter. Converted inch dimensions are not necessarily exact.
- 11. Dimensions "P" and "P1" are thermal and/or electrical enhanced variations. Values shown are maximum size of exposed pad within lead count and body size.



